1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 2 A
- Reverse voltage: V_R ≤ 60 V
- · Low forward voltage
- · High power capability due to clip-bonding technology
- · Small and flat lead SMD plastic package
- · AEC-Q101 qualified
- High temperature T_i ≤ 175 °C
- Capable for reflow and wave soldering

3. Applications

- Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IF	forward current	T _{sp} = 160 °C		-	-	2.8	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{amb} \le 100 ^{\circ}\text{C}$; square wave	[1]	-	-	2	A
		δ = 0.5; f = 20 kHz; $T_{sp} \le 165$ °C; square wave		-	-	2	Α
V_R	reverse voltage	T _j = 25 °C		-	-	60	V
V _F	forward voltage	I _F = 2 A; T _j = 25 °C		-	460	530	mV
I _R	reverse current	$V_R = 60 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$		-	60	150	μΑ
t _{rr}	reverse recovery time	$I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $T_j = 25 \text{ °C}$		-	8.5	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	1 2	К - [К]-А
2	Α	anode		sym001
			CFP3 (SOD123W)	

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package	je					
	Name	Description	Version				
PMEG6020ETR	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W				

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6020ETR	EL

Product data sheet

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	60	V
I _F	forward current	T _{sp} = 160 °C		-	2.8	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{amb} \le 100$ °C; square wave	[1]	-	2	А
		δ = 0.5; f = 20 kHz; $T_{sp} \le 165$ °C; square wave		-	2	А
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	50	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	680	mW
			[3]	-	1150	mW
			[1]	-	2140	mW
T _j	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient	thermal resistance from	in free air	[1] [2]	-	-	220	K/W
		[1] [3]	-	-	130	K/W	
		1	[1] [4]	-	-	70	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

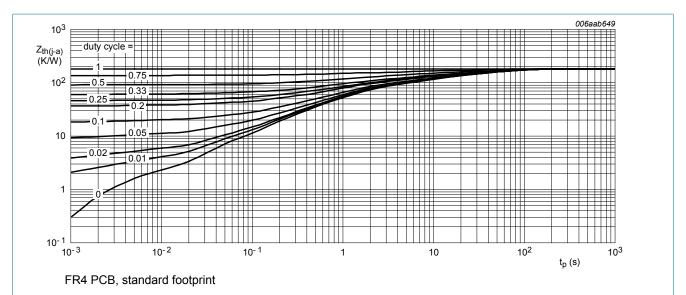


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

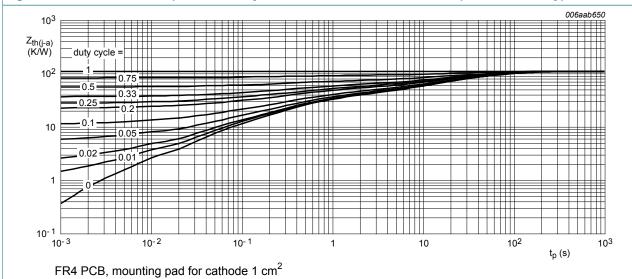


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

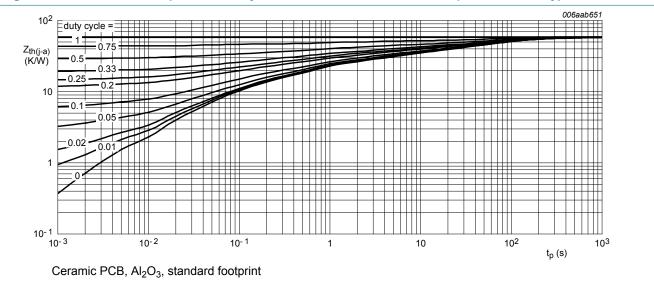
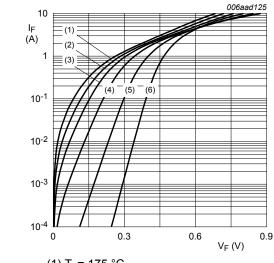


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C	-	300	340	mV
		I _F = 0.5 A; T _j = 25 °C	-	360	420	mV
		I _F = 1 A; T _j = 25 °C	-	400	460	mV
		I _F = 1.5 A; T _j = 25 °C	-	430	500	mV
		I _F = 2 A; T _j = 25 °C	-	460	530	mV
		I _F = 2 A; T _j = -40 °C	-	510	590	mV
		I _F = 2 A; T _j = 125 °C	-	410	480	mV
		I _F = 2 A; T _j = 150 °C	-	390	460	mV
		I _F = 2 A; T _j = 175 °C	-	375	450	mV
I _R	reverse current	$V_R = 5 \text{ V; } t_p \le 300 \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	2.5	-	μΑ
		$V_R = 10 \text{ V; } t_p \le 300 \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	3.5	-	μΑ
		$V_R = 60 \text{ V; } t_p \le 300 \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	60	150	μΑ
		$V_R = 60 \text{ V; } t_p \le 300 \mu\text{s; } \delta \le 0.02;$ $T_j = -40 \text{ °C; pulsed}$	-	0.9	15	μΑ
		$V_R = 60 \text{ V; } t_p \le 300 \mu\text{s; } \delta \le 0.02;$ $T_j = 125 \text{ °C; pulsed}$	-	27	100	mA
d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	240	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	80	-	pF
r	reverse recovery time	$I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $I_{j} = 25 \text{ °C}$	-	8.5	-	ns
/ _{FRM}	peak forward recovery voltage	I _F = 1 A; dI _F /dt = 40 A/μs; T _j = 25 °C	-	455	-	mV



(1) $T_i = 175 \,^{\circ}C$

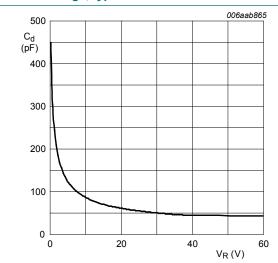
 $(2) T_i = 150 °C$

 $(3) T_i = 125 °C$

 $(4) T_i = 85 ^{\circ}C$ $(5) T_i = 25 ^{\circ}C$

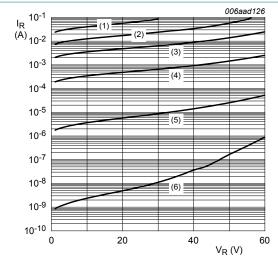
(6) $T_i = -40 \, ^{\circ}\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



 $f = 1 MHz; T_{amb} = 25 °C$

Diode capacitance as a function of reverse Fig. 6. voltage; typical values



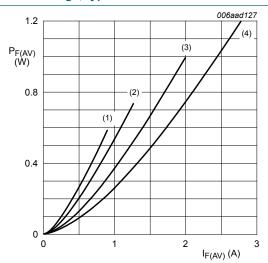
(1) $T_j = 175 \,^{\circ}\text{C}$ (2) $T_j = 150 \,^{\circ}\text{C}$

(3) $T_j = 125 \, ^{\circ}C$

 $(4) T_i = 85 ^{\circ}C$

 $(5) T_i = 25 ^{\circ}C$ (6) $T_i = -40 \,^{\circ}\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



T_i = 175 °C

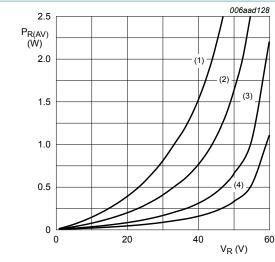
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 150 \,{}^{\circ}\text{C}$

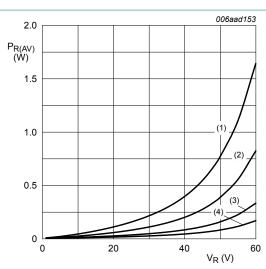
 $(1) \delta = 1$

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$

 $(4) \delta = 0.1$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



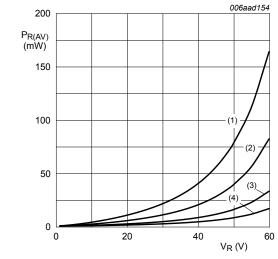
T_j = 125 °C

 $(1) \delta = 1$

 $(2) \delta = 0.5$

(3) $\delta = 0.2$ (4) $\delta = 0.1$

Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values



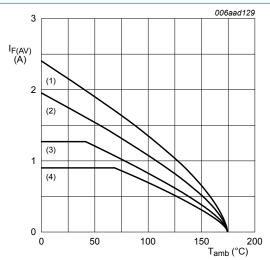
 $T_j = 85 \,^{\circ}C$

 $(1) \delta = 1$

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$ $(4) \delta = 0.1$

Fig. 10. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

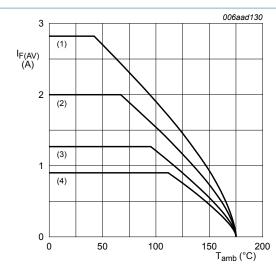
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

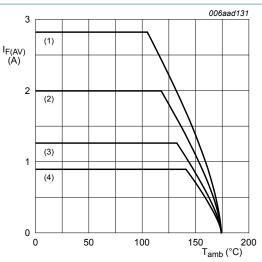
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

T_i = 175 °C

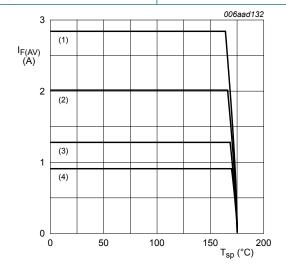
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 13. Average forward current as a function of ambient temperature; typical values



T_i = 175 °C

 $(1) \delta = 1 (DC)$

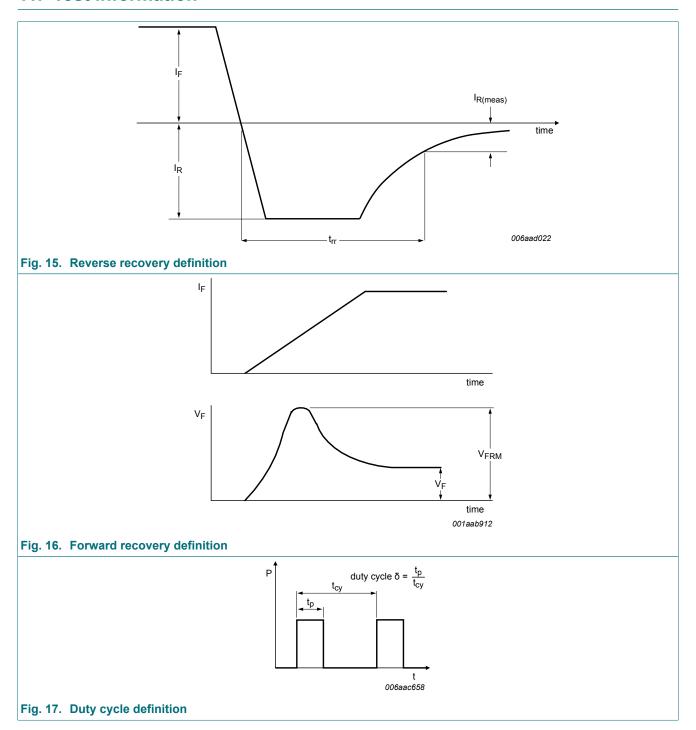
(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 14. Average forward current as a function of solder point temperature; typical values

11. Test information

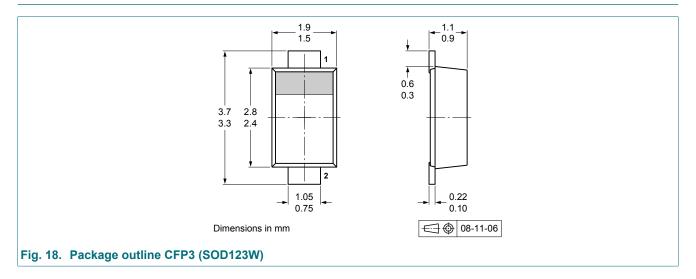


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

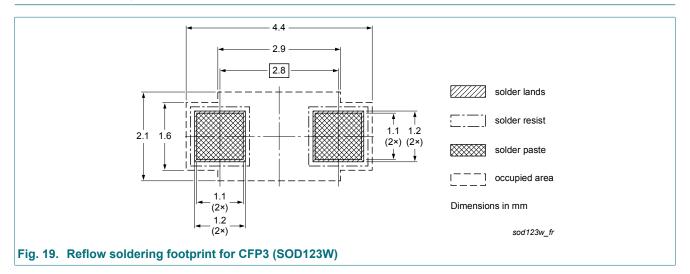
Quality information

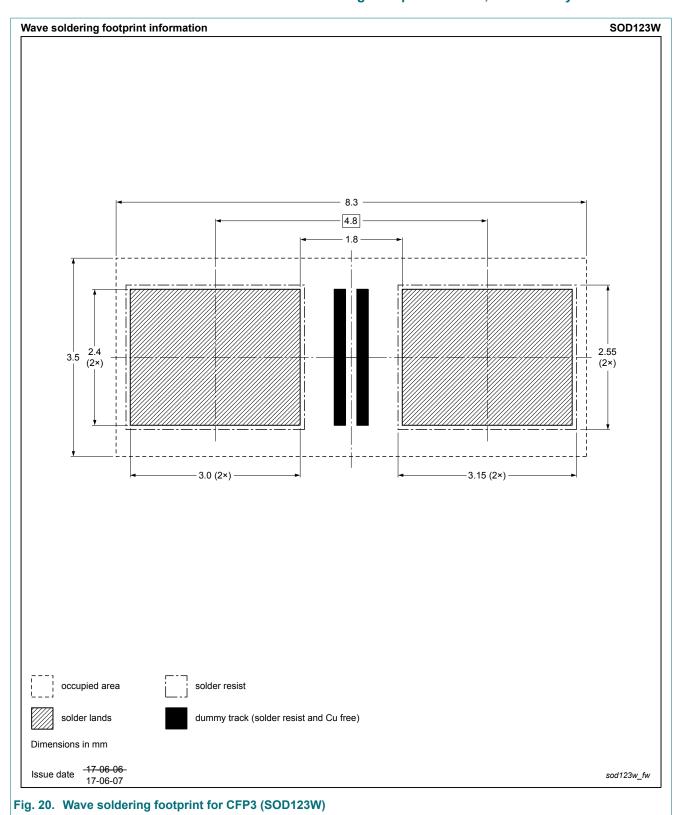
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMEG6020ETR_2	20180822	Product data sheet	-	PMEG6020ETR v.1		
Modifications:	 Features and benefits: Capable for reflow and wave soldering added Soldering: Wave soldering footprint added 					
PMEG6020ETR v.1	20121011	Product data sheet	-	-		

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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High-temperature 60 V, 2 A Schottky barrier rectifier

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PMEG6020ETR

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Date of release: 22 August 2018

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